

Design guide

N32G401 series crystal selection guide

Introduction

This document details the crystal selection guide for N32G401 series MCUs to provide users reference.

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1. Description for crystal selection

1.1 Application circuit for crystal

Figure 1-1 is the typical application circuit for crystal, feedback resistor(R_F) is embedded in the oscillator circuitry, No external resistance is required.

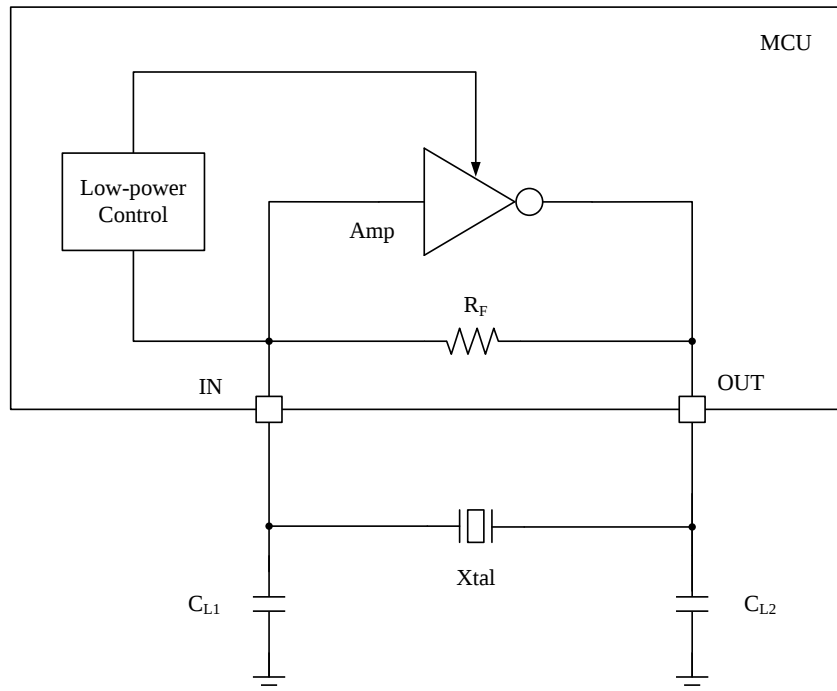


Figure 1-1 Typical application with a 32.768 kHz crystal

1.2 Selection of Capacitors

The low-speed external (LSE) clock can be supplied with a 32.768 kHz crystal/ceramic resonator oscillator. In the application, the resonator and the load capacitors have to be placed as close as possible to the oscillator pins in order to minimize output distortion and startup stabilization time. Refer to the crystal resonator manufacturer for more details on the resonator characteristics (frequency, package, accuracy).

For C_{L1} and C_{L2} it is recommended to use high-quality ceramic capacitors to match the requirements of the crystal, C_{L1} and C_{L2} , are usually the same value.

Load capacitance CL has the following formula: $CL = C_{L1} \times C_{L2} / (C_{L1} + C_{L2}) + C_{stray}$ where C_{stray} is the pin capacitance and board or trace PCB-related capacitance.

Example: if you choose a crystal with a load capacitance of $CL = 7$ pF, and $C_{stray} = 2$ pF, then $C_{L1} = C_{L2} = 10$ pF.

1.3 Crystal test

1. 3. 1 LSE parameter configuration

When using the LSE external crystal, call the void `RCC_LSE_Config (uint32_t RCC_LSE, uint16_t LSE_Trim)` function, and configure the LSE parameters through the input parameter `uint16_t LSE_Trim`. For details, see the following code example:

```

/**
 * \name      RCC_LSE_Config.
 * \fun       Configures the External Low Speed oscillator (LSE).
 * \param     RCC_LSE(the new state of the LSE):
 * \param     - RCC_LSE_DISABLE      LSE oscillator OFF
 * \param     - RCC_LSE_ENABLE       LSE oscillator ON
 * \param     - RCC_LSE_BYPASS       LSE oscillator bypassed with external clock
 * \param     LSE_Trim(LSE Driver Trim Level):
 * \param     - 0x00~0x1FF
 * \return    none
 */
void RCC_LSE_Config(uint32_t RCC_LSE,uint16_t LSE_Trim)
{
    /* Enable PWR Clock */
    RCC_APB1_Peripheral_Clock_Enable(RCC_APB1_PERIPH_PWR);
    /* PWR DBKP set 1 */
    PWR->CTRL |= PWR_CTRL_DBKP;

    /* Reset LSEON LSEBP bits before configuring the LSE */
    *(__IO uint32_t*)RCC_BDCtrl_ADDR &= ~(RCC_LSE_ENABLE | RCC_LSE_BYPASS);
    /* Configure LSE (RCC_LSE_DISABLE is already covered by the code section above) */
    switch (RCC_LSE)
    {
        case RCC_LSE_ENABLE:
            /* Set LSEON bit */
            *(__IO uint32_t*)RCC_BDCtrl_ADDR |= RCC_LSE_ENABLE;
            RCC_LSE_Trim_Config(LSE_Trim);
            break;
        case RCC_LSE_BYPASS:
            /* Set LSEBYP and LSEON bits */
            *(__IO uint32_t*)RCC_BDCtrl_ADDR |= (RCC_LSE_BYPASS | RCC_LSE_ENABLE);
            break;
        default:
            break;
    }
}

```

Different configuration values have a great influence on the characteristics of the final crystal. The recommended LSE configuration parameter value is 0x1D7.

1. 3. 2 Crystal frequency test

1.3.2.1 Crystal frequency test @ 25°C

Referring to the peripheral hardware design in Figure 1-1, select a crystal and connect an external capacitor to test the crystal frequency. The crystal signal can be output to a frequency meter or other frequency testing instruments through the MCO.

- Example:

The selected crystal load capacitance $CL=9pF$, and the frequency tolerance is $\pm 20ppm$. C_{stray} is calculated by $4pF$, then $CL_1=CL_2=10pF$.

(The value of C_{stray} is related to different test board hardware, the user can fine-tune CL_1 and CL_2 according to the test frequency value)

Refer to Figure 1-2 for the output frequency value of the normal temperature (25°C) when the LSE configuration parameter value is 0x1D7.

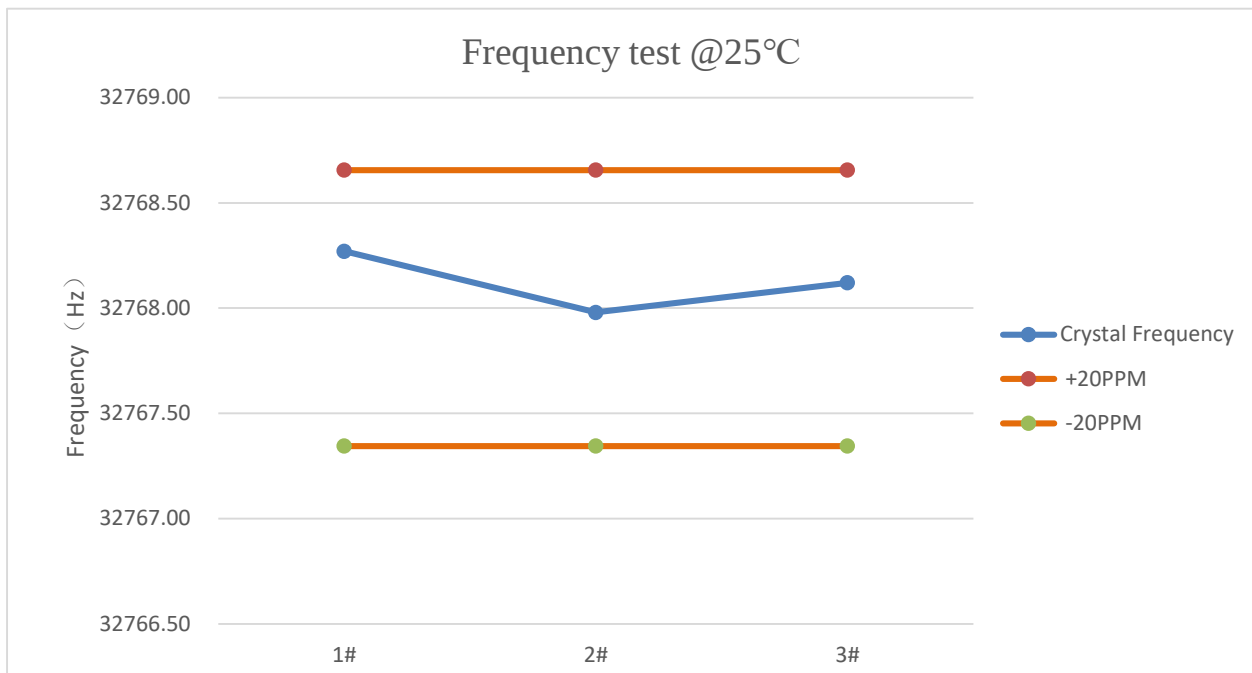


Figure 1-2 25°C, $C_{L1}=C_{L2}=10\text{pF}$, LSE configuration parameter=0x1D7, crystal output frequency

As can be seen from Figure 1-2, under normal temperature conditions, the output frequencies of the three test boards are all within $\pm 20\text{ppm}$.

1.3.2.2 Crystal frequency test @-40~85°C

Referring to Figure 1-3, for the output frequency value of the crystal operation temperature (-40~85°C) when the LSE configuration parameter value is 0x1D7.

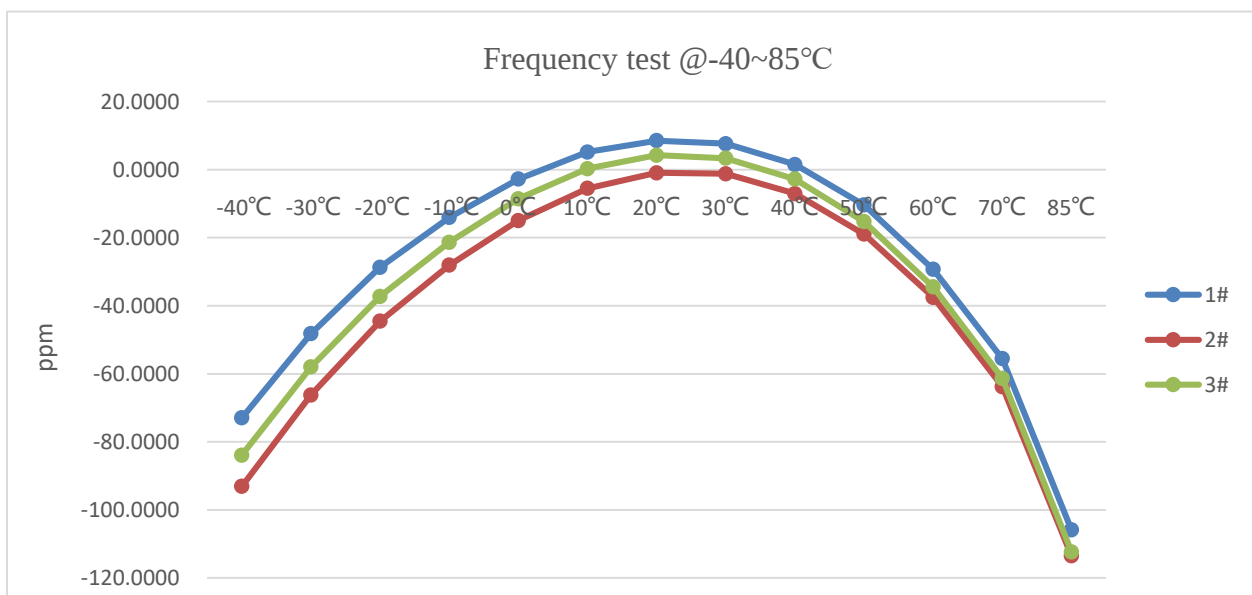


Figure 1-3 -40~85°C, $C_{L1}=C_{L2}=10\text{pF}$, LSE configuration parameter=0x1D7, crystal output frequency

1. 3. 3 Crystal Compatibility test

When selecting an external 32.768KHz crystal for the N32G401 chip, it should be noted that the selected crystal can work in the full operating temperature range.

The LSE configuration parameters are different, and the crystal models that can be adapted are also different. Refer to Table 1-1 for the crystal full temperature test compatibility list. The LSE configuration parameter is 0x1D7.

Table 1-1 crystal compatibility list

No.	Product name/Part Number	Package	Manufacturer	CL (pF)	CO (pF)	ESR(max) (kΩ)	Temp Range (°C)
1	TFX-04-32.768K(7PF)	1610	RIVER	7	1.3	90	-40~85
2	TFX-04-32.768K			12.5	1.3	90	
3	1TJH090DR1A0086		KDS	9	1.3	90	
4	DST1610A 32.768KHz			12.5	1.3	90	
5	X1A0001210005		EPSON	12.5	1.2	90	
6	SC-16S 32.768kHz 20PPM 12.5pF		SEIKO	12.5	1.2	90	
7	ABS06-32.768KHZ-T	2012	ABRACON	12.5		90	
8	SC-20S,32.768kHz,20PPM,7pF		SEIKO	7	1.3	90	
9	FC-12M 32.768000 kHz 7.0+20.0-20.0/X1A0000610006		EPSON	7	1.3	90	
10	TJXM32768K2TGDCNT2T		TAE	12.5		70	
11	1TJG125DR1A0019		KDS	12.5	1.3	80	
12	FC-135R 32.768KHz 9PF 20PPM/ X1A0001410002	3215	EPSON	9	1.1	50	
13	FC-135 32.768KHz 9PF 20PPM/ Q13FC13500003			9	1	70	
14	FC-135 32.768KHz 7PF 20PPM/ Q13FC13500002			7	1	70	
15	FC-135 32.768kHz 6PF 20PPM/ Q13FC1350004900			6	1	70	
16	FC-135 32.768KHz 12.5PF 20PPM/ Q13FC13500004			12.5	1.2	70	
17	FC-135 32.768KHz 9PF 20PPM			9	1	70	
18	SC-32S 32.768kHz 7pF 20ppm		SEIKO	7	1	70	
19	SC-32S 32.768kHz 12.5pF 20ppm			12.5	1	70	
20	SC-32S 32.768kHz 9pF 20ppm			9	1	70	
21	SC-32S 32.768kHz 6pF 20ppm			6	1	70	
22	1TJF125DP1A000A		KDS	12.5	1.3	80	
23	NX3215SA-32.768kHz-EXS00A- MU00202		NDK	7	1	70	
24	7LC32768F12UC		SJK	12.5	1.2	70	
25	7LC32768F07UC			7	1.2	70	
26	SF32WK32768D71T005		TKD	7	1.1	70	

27	SF32WK32768D61T002			6	1.1	70	
28	FC31M2-32.768-NTLLD			12.5	1.5	70	
29	FC31M2-32.768-N09LLD		HCI	9	1.5	70	
30	X321532768KGD2SI		YXC	12.5	1.2	70	
31	ETST00327000JE		HOSONIC	12.5	2	70	
32	TCXM32768K2NGDCZT2T		TAE	12.5	2	80	
33	XDMCZLNDDF-0.032768MHZ		TAITIEN	12.5			
34	KFC3276812520		KYX	12.5	1.2	70	
35	F3K232768PWQAC		JYJE	12.5		70	
36	26S-32.768-12.5-10-10/B	DT26	LIMING	12.5		90	
37	MC-146 32.768KHz 9PF 20PPM/ Q13MC14610004		EPSON	9	0.8	65	
38	MC-146 32.768KHz 12.5PF 20PPM/ Q13MC14620002			12.5	0.8	65	
39	SSP-T7-F 32.768kHz 20PPM 12.5pF		SEIKO	12.5	0.8	65	
40	SSP-T7-F 32.768kHz 20PPM 7pF	MC-146		7	0.8	65	
41	FR07S4-32.768-N07LLD		HCI	7	0.8	65	
42	FR07S4-32.768-NTLLD			12.5	0.8	65	
43	TSXM32768K4KGDCZT3T		TAE	12.5	0.8	65	
44	7MC32768F12UC		SJK	12.5	1.2	70	
45	6LC32768F12UC		SJK	12.5	1.2	50	
46	6LC32768F06UC			6	1.2	50	
47	MC-306 32.768kHz 6PF 20PPM/ Q13MC3062000600	MC-306	EPSON	6	0.9	50	
48	X803832768KID4GI		YXC	6		70	
49	FR08S4-32.768-N06LLD		HCI	6	0.9	50	
50	CD01K032768FEPBAEAE		TKD	8	1.4	40	
51	CD01K032768ACNBAEAE			12.5	1.4	40	
52	Y26003271C2040DYJY	DT26	JGHC	12.5		40	
53	X206032768KGB2SC		YXC	12.5		40	
54	WTL2T45292LZ		WTL	12.5	1.5	40	
55	146-32.768-12.5-20-20/A		LIMING	12.5			
56	7L032768NW2	MC-146	HD	12.5	0.8	65	
57	X308032768KGB2SC		YXC	12.5		40	
58	CD02K032768AEPBAEAE	DT38	TKD	12.5	1.8	30	
59	38-32.768-12.5-10/A		LIMING	12.5			
60	S3132768092070			9	1	65	
61	SMD31327681252090	3215	JGHC	12.5	1	65	
62	S3132768072070			7	1	65	
63	DT-26-32.768K 6pF 20PPM			6	1.1	40	
64	DT-26 32.768KHz	DT26	KDS	12.5	1.1	40	
65	DT-38 32.768KHz		KDS	12.5	1.3	30	
66	Y308327681252075	DT38	JGHC	12.5	1.1	40	

Note:

1. The chip power supply voltage for the above crystal compatibility test is VDD=3.3V.
2. It is recommended that customers use the crystals in the above compatible list, and customers need to confirm whether the crystals are available through production testing.
3. If the crystal model used is not in the compatibility list, please contact NSING Technologies Inc.

2. Version history

Version	Date	Modify
V1.0.0	2023-05-16	Initial version.

3. Notice

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